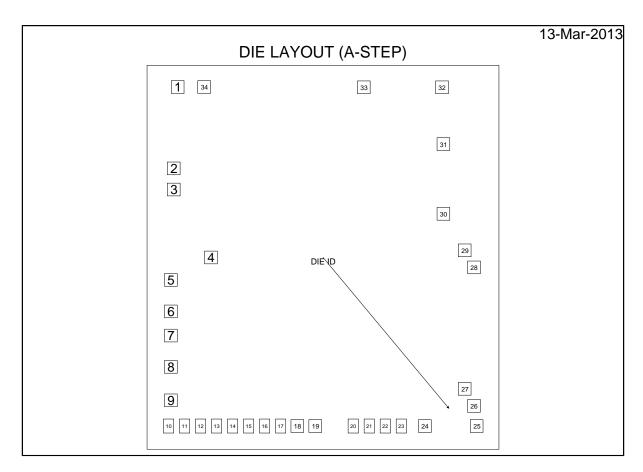


LM5575Q0-MDC MWC SIMPLE SWITCHER® 75V, 1.5A STEP-DOWN SWITCHING REGULATOR



DIE/WAFER CHARACTERISTICS

DIE/WAFER CHARA	CIERISTICS			
Fabrication Attributes		General Die Information		
Physical Die	LM5575A	Bond Pad Opening	91.00µm x 91.00µm	
Identification		Size (min)		
Die Step	A	Bond Pad Metalization	AL 0.5%CU	
Physical Attributes		Passivation	PECVDOX NITRIDE	
Wafer Diameter	152.4mm	Back Side Metal	BAREBACK	
Die Size (Drawn)	2514.60µm x 2743.20µm	Back Side Connection	Floating	
	99.0mils x 108.0mils			
Thickness	254µm Nominal			
Min Pitch	128.00µm			
Note: All values are rounded to the nearest micron.				
Special Assembly Requirements:				



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Die Bond Pad Coordinate Locations(A-Step) (Referenced to die center, coordinates in μ m) NC = No Connection, N.U. = Not Used Signal Name Pad Number X/Y Coordinates Pad Size Χ Χ Υ SD 1 -1038.50 1217.00 91.00 91.00 Χ VIN 2 -1066.50 635.50 91.00 91.00 Х VIN 3 -1066.50 484.50 91.00 91.00 Х 4 -1.00 VIN -801.00 91.00 Х 91.00 SYNC 5 -1087.00 -161.50 91.00 91.00 Χ 6 91.00 COMP -1087.00 -386.50 Х 91.00 FΒ 7 -1087.00 -559.00 91.00 91.00 Х RT 8 -1087.00 -782.50 91.00 91.00 Х **RAMP** 91.00 9 -1087.00 -1022.00 91.00 Х NC 10 -1104.00 -1205.50 73.00 100.00 Х NC 11 73.00 100.00 -989.50 -1205.50 Х NC 12 -875.00 -1205.50 73.00 100.00 Х NC 73.00 100.00 13 -760.50 -1205.50 Х NC 14 73.00 100.00 -646.00 -1205.50 Х NC 15 -531.50 -1205.50 73.00 Χ 100.00 NC 16 -417.00 -1205.50 73.00 100.00 Χ NC 17 -302.50 -1205.50 73.00 Х 100.00 **AGND** 18 91.00 91.00 -183.50 -1205.50 Х **AGND** 19 -55.50 -1205.50 91.00 91.00 Х NC 20 73.00 100.00 216.00 -1205.50 Х NC 21 330.50 -1205.50 73.00 100.00 Χ NC 22 445.00 -1205.50 73.00 100.00 Χ NC 23 559.50 -1205.50 73.00 100.00 Χ SS 91.00 24 728.00 -1205.50 91.00 Х OUT 25 1098.00 -1205.50 91.00 91.00 Х 91.00 **PGND** 26 1079.00 -1061.50 Х 91.00 **PGND** 27 1012.50 -939.50 91.00 91.00 Х IS 28 -72.00 91.00 1079.00 91.00 Х IS 29 50.00 91.00 1012.50 91.00 Х SW 30 860.50 311.00 91.00 91.00 Х SW 31 860.50 809.00 91.00 Χ 91.00 **PRE** 32 850.50 1215.00 91.00 Χ 91.00 33 **BST** 291.50 1215.00 91.00 91.00 Х **VCC** 34 -849.50 1217.00 91.00 91.00 Х



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